


APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	ISOLATION STRUCTURES IN SEMICONDUCTOR INTEGRATED CIRCUITS (IC)		
Application Type : regular, utility			
Attorney Docket Number : BUR920040170US1			
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Customer Number:		30449	
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

Assignee 1:

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